



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Typical Applications

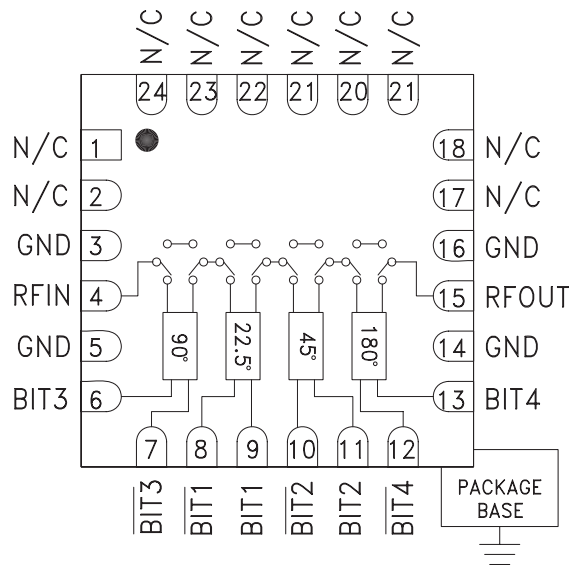
The HMC543LC4B is ideal for:

- EW Receivers
- Weather & Military Radar
- Satellite Communications
- Beamforming Modules

Features

- Low RMS Phase Error: 5°
- Low Insertion Loss: 6.5 dB
- Excellent Flatness
- 360° Coverage, LSB = 22.5°
- 24 Lead Ceramic SMT Package: 16mm²

Functional Diagram



General Description

The HMC543LC4B is a 4-bit digital phase shifter which is rated from 8 to 12 GHz, providing 0 to 360 degrees of phase coverage, with a LSB of 22.5 degrees. The HMC543LC4B features very low RMS phase error of 5 degrees and extremely low insertion loss variation of ± 0.8 dB across all phase states. This high accuracy phase shifter is controlled with complementary logic of 0/-3V, and requires no fixed bias voltage. The HMC543LC4B is housed in a compact 4x4 mm ceramic leadless SMT package and is internally matched to 50 Ohms with no external components. Simple external level shifting circuitry can be used to convert a positive CMOS control voltage into complementary negative control signals.

Electrical Specifications, $T_A = +25^\circ\text{C}$, 50 Ohm System, Control Voltage = 0/-3V

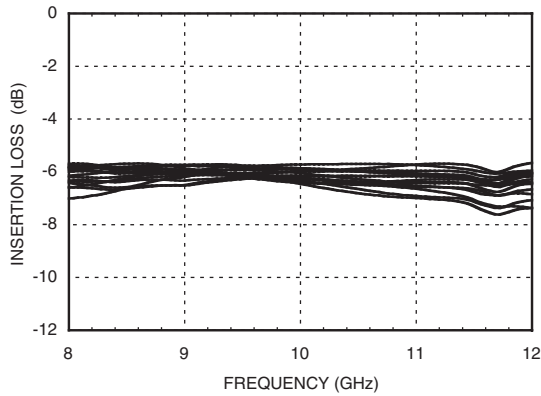
Parameter	Min.	Typ.	Max.	Units
Frequency Range	8		12	GHz
Insertion Loss*		6.5	8	dB
Input Return Loss*		10		dB
Output Return Loss*		10		dB
Phase Error*		± 10	± 15	deg
RMS Phase Error		5		deg
Gain Variation*		± 0.8		dB
Input Power for 1 dB Compression	21	24.5		dBm
Input Third Order Intercept		40		dBm
Control Voltage Current		7		mA

*Note: All States Shown

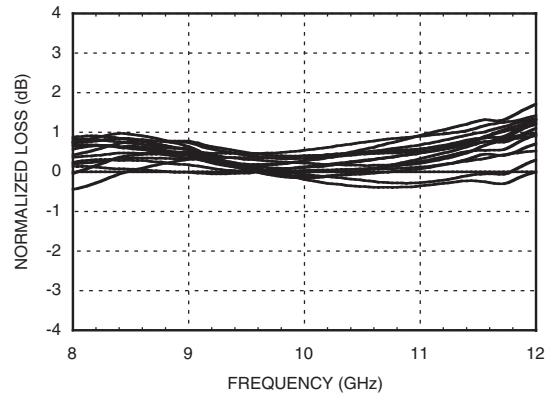


**22.5° MMIC 4-BIT DIGITAL
PHASE SHIFTER, 8 - 12 GHz**

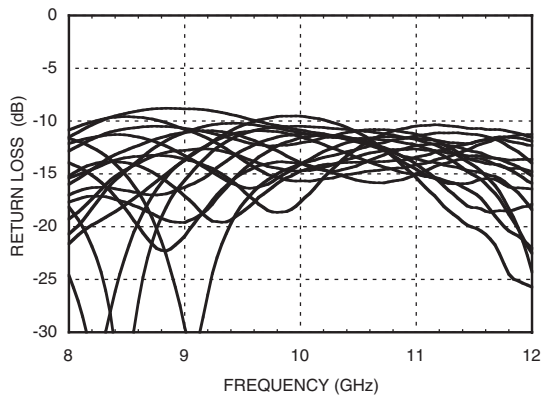
Insertion Loss, All States



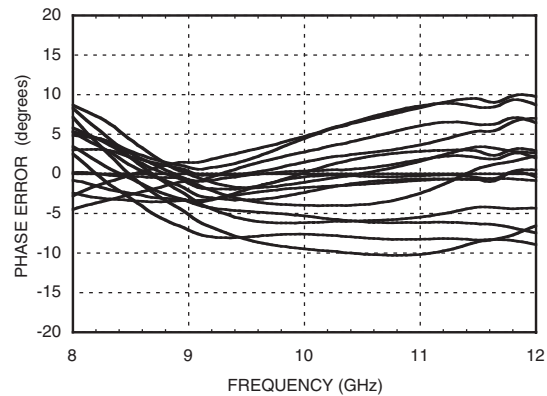
Normalized Loss, All States



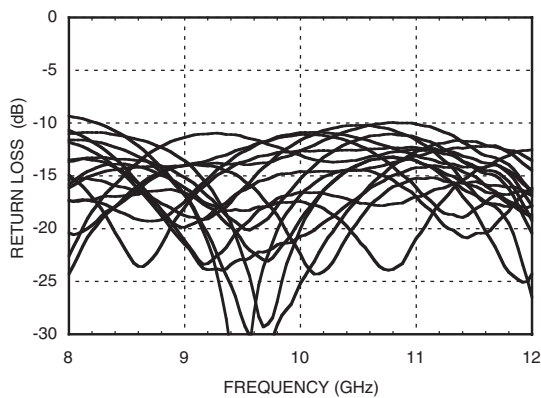
Input Return Loss, All States



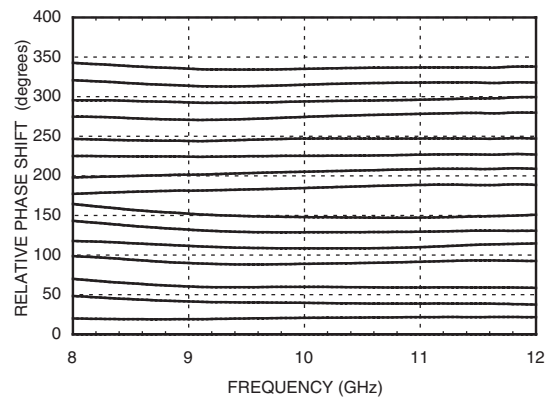
Phase Error, All States



Output Return Loss, All States

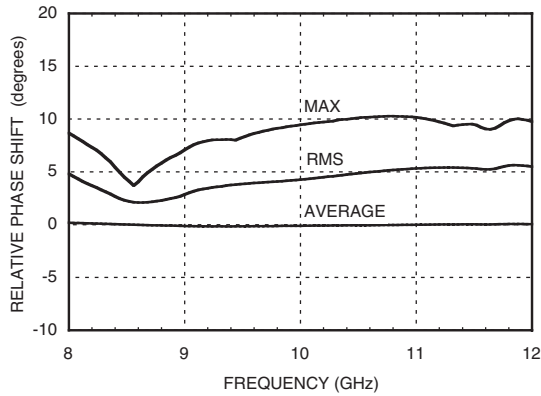


Relative Phase Shift, All States

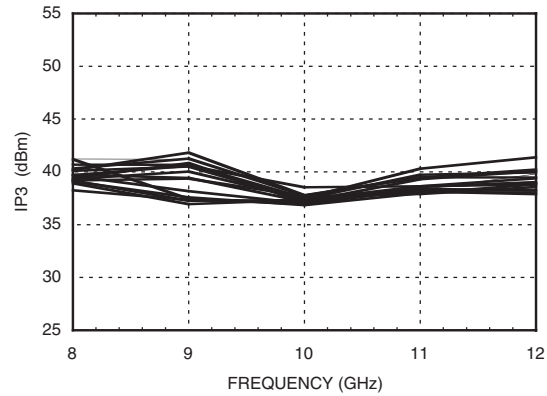


22.5° MMIC 4-BIT DIGITAL PHASE SHIFTER, 8 - 12 GHz

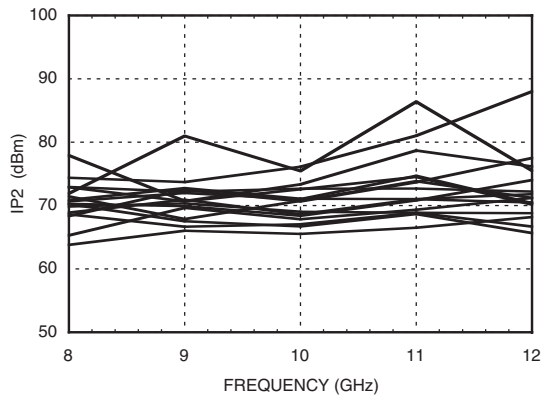
Relative Phase Shift, RMS, Average, Max, All States



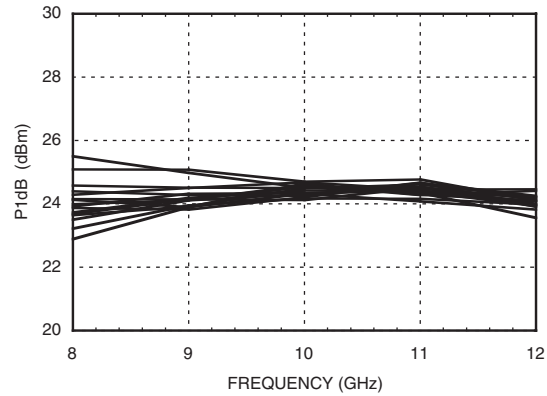
Input IP3, All States



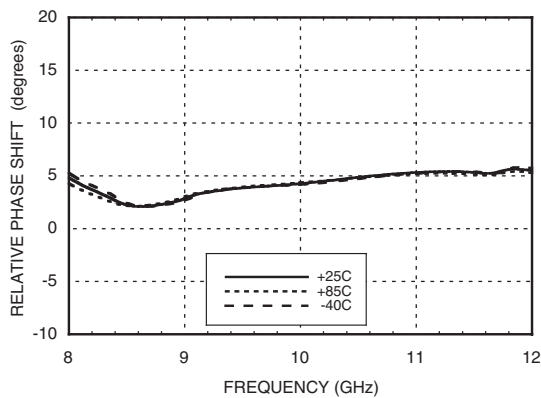
Input IP2, All States



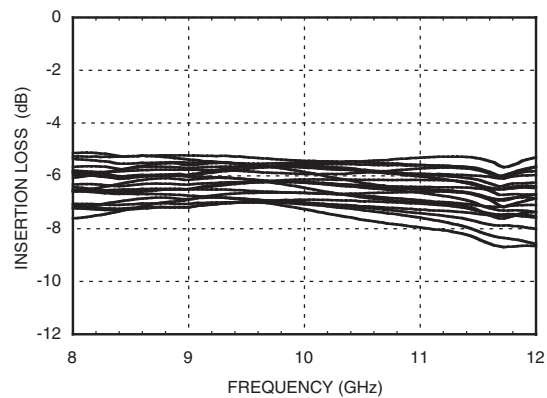
Input P1dB, All States



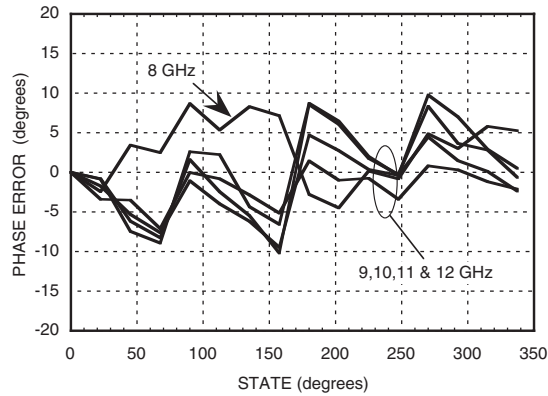
RMS Phase Error vs. Temperature



Insertion Temperature All States



Phase Error vs. State



Absolute Maximum Ratings

Input Power (RFin) (8-12 GHz)	+27 dBm (T= +85 °C)
Channel Temperature (Tc)	150 °C
Thermal Resistance (channel to ground paddle)	150 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1B

Control Voltage

State	Bias Condition
Low	-2.5 to -3.5V @ 0.4 μA Typ.
High	0 to +0.3V @ 0.4 μA Typ.



**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**

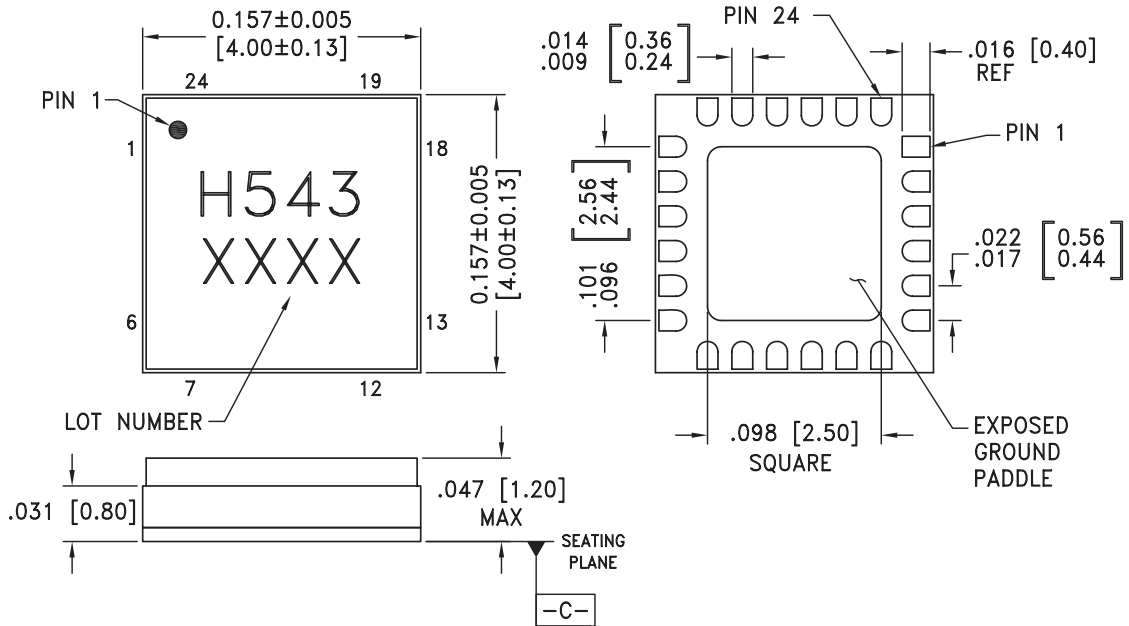
Truth Table

Control Voltage Input								Phase Shift (Degree) RFIN - RFOUT
Bit 1	$\overline{\text{Bit 1}}$	Bit 2	$\overline{\text{Bit 2}}$	Bit 3	$\overline{\text{Bit 3}}$	Bit 4	$\overline{\text{Bit 4}}$	
0	1	0	1	0	1	0	1	Reference
1	0	0	1	0	1	0	1	22.5
0	1	1	0	0	1	0	1	45.0
0	1	0	1	1	0	0	1	90.0
0	1	0	1	0	1	1	0	180.0
1	0	1	0	1	0	1	0	337.5

Any combination of the above states will provide a phase shift approximately equal to the sum of the bits selected.

Outline Drawing

BOTTOM VIEW


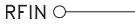


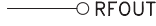


NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM $-C-$
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. CLASSIFIED AS MOISTURE SENSITIVITY LEVEL (MSL) 1.



Pin Descriptions

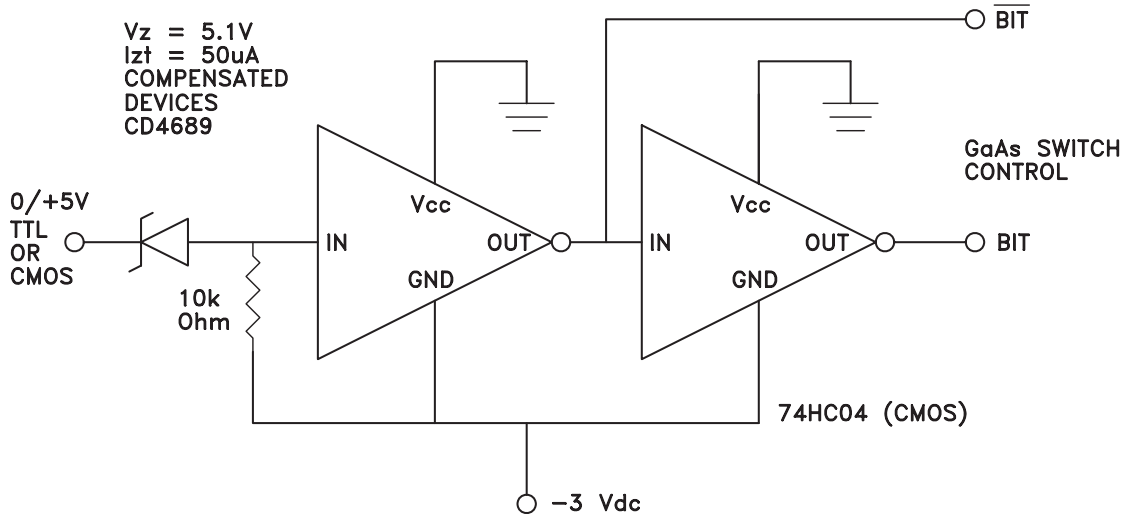
Pin Number	Function	Description	Interface Schematic
1, 2, 17 - 24	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
3, 5, 14, 16	GND	These pins and exposed ground paddle must be connected to RF/DC ground.	
4	RFIN	This port is matched to 50 Ohms.	
6, 9, 11, 13	BIT1, BIT2, BIT3, BIT4	Non-Inverted Control Input. See truth table and control voltage tables.	
7, 8, 10, 12	$\overline{\text{BIT1}}, \overline{\text{BIT2}}$ $\overline{\text{BIT3}}, \overline{\text{BIT4}}$	Inverted Control Input. See truth table and control voltage tables.	
15	RFOUT	This port is matched to 50 Ohms.	



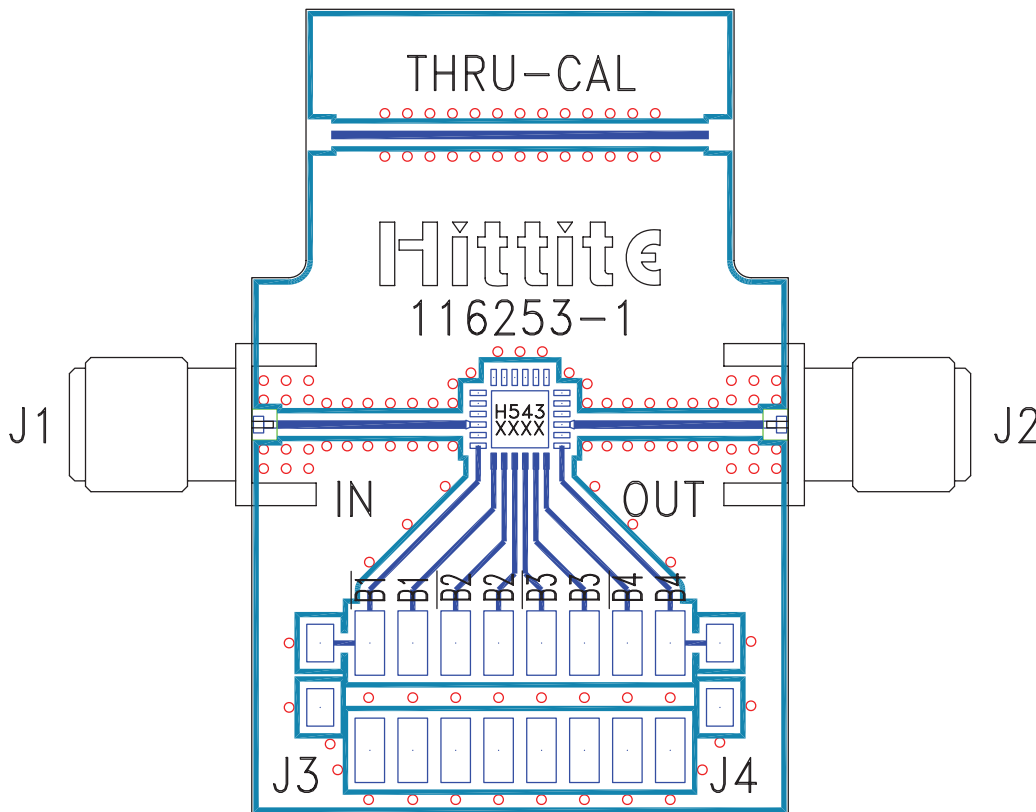
22.5° MMIC 4-BIT DIGITAL PHASE SHIFTER, 8 - 12 GHz

Application Circuit

This circuit converts a single line positive (0/+5V) control signal to complementary negative (0/-3V) control signals.



Evaluation PCB



List of Materials for Evaluation PCB 108812 [1]

Item	Description
J1 - J2	PCB Mount SMA RF Connector
J3 - J4	Molex Header 2mm
U1	HMC543LC4B 4-Bit Digital Phase Shifter
PCB [2]	116253 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.